

N-Channel Enhancement Mode MOSFET

1. Product Information

1.1 Features

- ☒ SGT Technology
- ☒ Low $F_{OM} R_{DS(ON)} \times Q_{gd}$

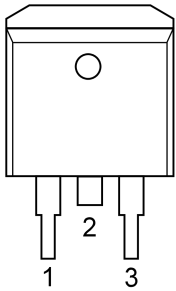
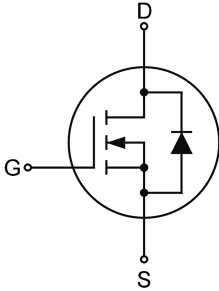
1.2 Applications

- ☒ PWM Application
- ☒ Power Management
- ☒ Load Switch

1.3 Quick reference

- ☒ $BV \geq 80\text{ V}$
- ☒ $R_{DS(ON)} \leq 3.5\text{ m}\Omega @V_{GS} = 10\text{ V}$
- ☒ $P_D \leq 192\text{ W}$
- ☒ $I_D \leq 170\text{ A}$

2. Pin Description

Pin	Description	Simplified Outline	Symbol
1	Gate (G)	 Top View TO-263	
2	Drain (D)		
3	Source (S)		

3. Limiting Values

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DS}	Drain-Source Voltage	$T_C=25^{\circ}\text{C}$	80	-	V
V_{GS}	Gate-Source Voltage	$T_C=25^{\circ}\text{C}$	-	± 20	V
I_D	Drain Current (DC)	$T_C=25^{\circ}\text{C}, V_{GS}=10\text{ V}$	-	170	A
		$T_C=100^{\circ}\text{C}, V_{GS}=10\text{ V}$	-	132	A
I_{DM}^*	Pulsed Source Current	$T_C=25^{\circ}\text{C}, V_{GS}=10\text{ V}$	-	510	A
P_D	Total Power Dissipation	$T_C=25^{\circ}\text{C}$	-	192	W
E_{AS}	Single Pulsed Avalanche Energy	$V_{DD}=40\text{ V}, L=3\text{ mH}$	-	864	mJ
T_J, T_{stg}	Operating Junction and Storage Temperature Range		-55	150	$^{\circ}\text{C}$
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient		-	41	$^{\circ}\text{C/W}$
$R_{\theta JC}$	Thermal Resistance, Junction to Case		-	0.65	

Notes:

- * Pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$.
- ** Surface Mounted on 1 in² pad area, $t \leq 10\text{ sec}$.
- *** Limited by maximum junction temperature.

4. Marking Information

Product Name	Marking
KJ03N08D	KJ03N08D XXXXXX-X

5. Ordering Code

Product Name	Package	Reel size	Tape width	Quantity (pcs)
KJ03N08D	TO-263	13"	24 mm	800

Note: KUAIJIE XIN defines "Green" as lead-free (RoHS compliant) and halogen free (Br or Cl does not exceed 900 ppm by weight in homogeneous material and total of Br and Cl does not exceed 1500 ppm by weight; Follow IEC 61249-2-21 and IPC/JEDEC J-STD-020C).

6. Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Static Characteristics						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0 V, I _{DS} =250 μA	80	-	-	V
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _{DS} =250 μA	2	-	4	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =64 V, V _{GS} =0 V	-	-	1	μA
I _{GSS}	Gate Leakage Current	V _{DS} =0 V, V _{GS} =±20 V	-	-	±100	nA
R _{DS(ON)}	On-State Resistance	V _{GS} =10 V, I _{DS} =20 A	-	2.5	3.5	mΩ
R _g	Gate Resistance	Frequency=1.0 MHz	-	0.9	-	Ω
Diode Characteristics						
V _{SD}	Diode Forward Voltage	I _{SD} =20 A, V _{GS} =0 V	-	-	1.2	V
t _{rr}	Reverse Recovery Time	I _{DS} =20 A, V _{GS} =0V, dI _{SD} /dt=100 A/μs	-	80	-	ns
Q _{rr}	Reverse Recovery Charge		-	150	-	nC
Dynamic Characteristics						
C _{iss}	Input Capacitance	V _{GS} =0 V, V _{DS} =40 V, Frequency=1.0 MHz	-	6400	-	pF
C _{oss}	Output Capacitance		-	1250	-	
C _{rss}	Reverse Transfer Capacitance		-	25	-	
t _{d(on)}	Turn-on Delay Time	V _{DS} =40 V, V _{GEN} =10 V, R _G =6 Ω, I _{DS} =20 A	-	30	-	ns
t _r	Turn-on Rise Time		-	38	-	
t _{d(off)}	Turn-off Delay Time		-	60	-	
t _f	Turn-off Fall Time		-	32	-	
Gate Charge Characteristics						
Q _g	Total Gate Charge	V _{DS} =10 V, V _{GS} =0 to 10 V, I _{DS} =20 A	-	90	-	nC
Q _{gs}	Gate-Source Charge		-	25	-	
Q _{gd}	Gate-Drain Charge		-	19	-	

7. Typical Characteristics

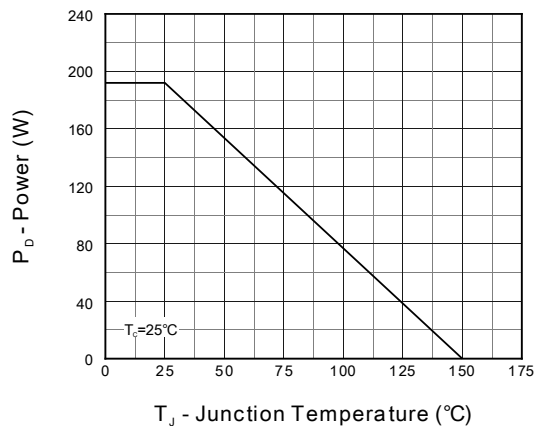


Figure 1. Power Capability

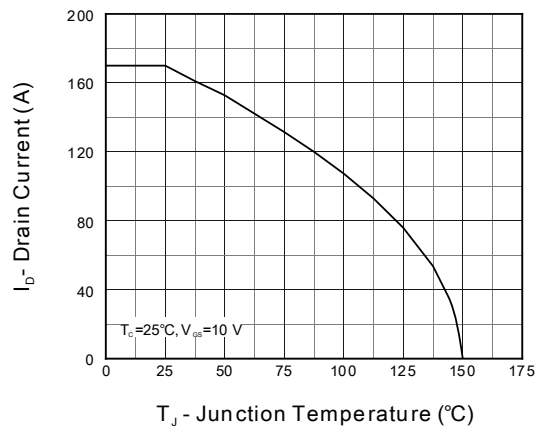


Figure 2. Current Capability

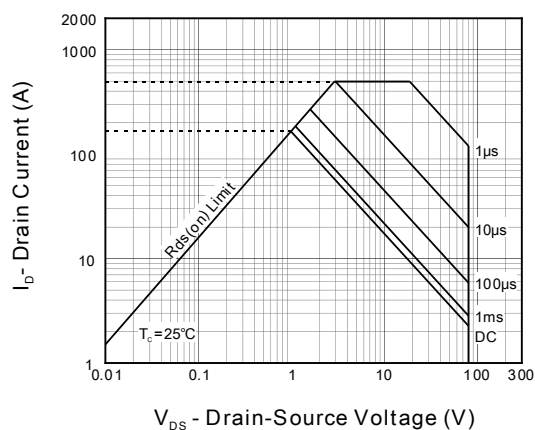


Figure 3. Safe Operation Area

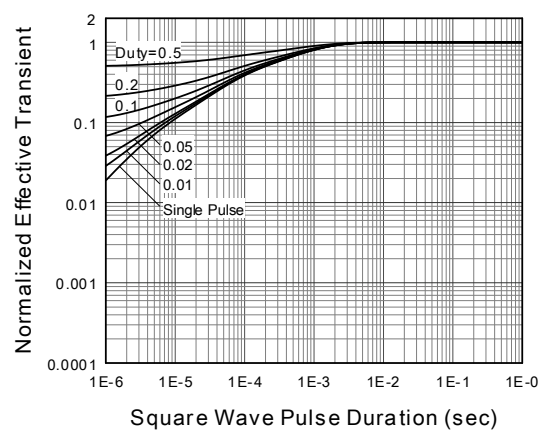


Figure 4. Transient Thermal Impedance

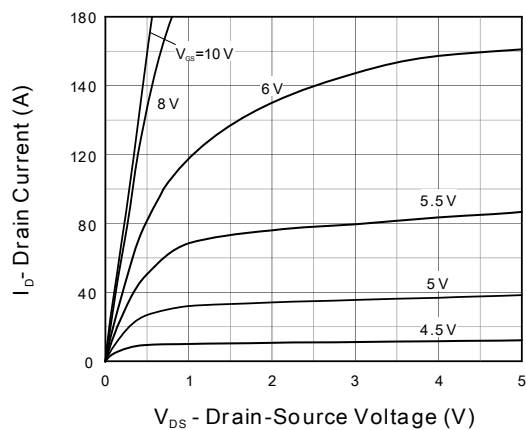


Figure 5. Output Characteristics

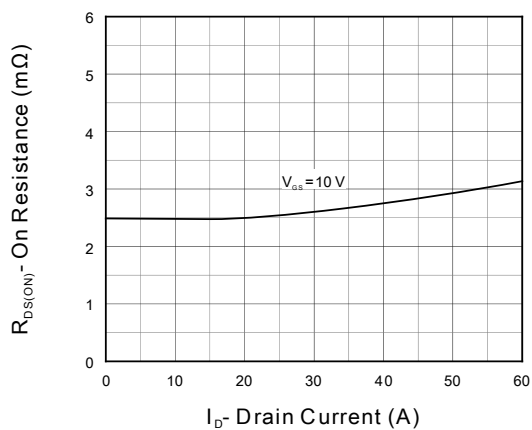


Figure 6. On Resistance

7. Typical Characteristics (cont.)

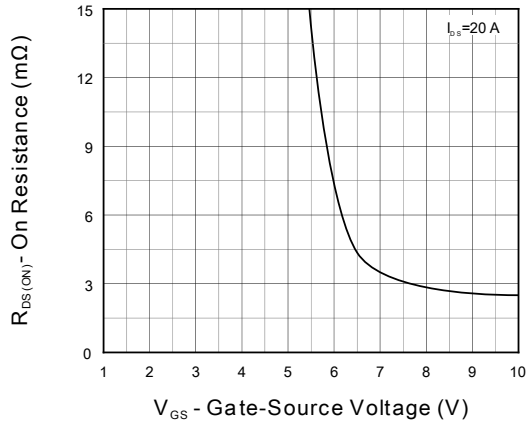


Figure 7. Transfer Characteristics

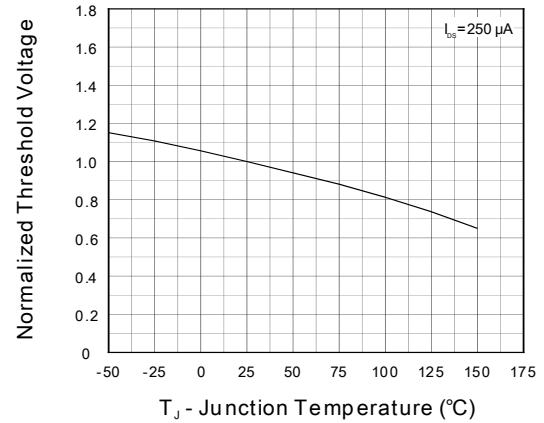


Figure 8. Normalized Threshold Voltage

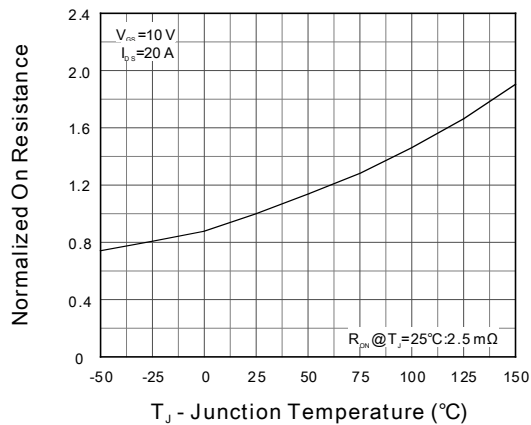


Figure 9. Normalized On Resistance

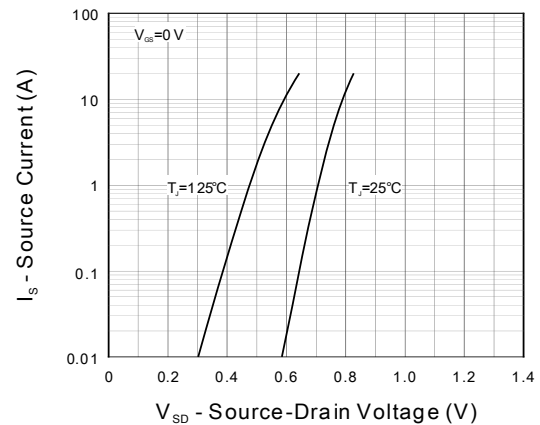


Figure 10. Diode Forward Current

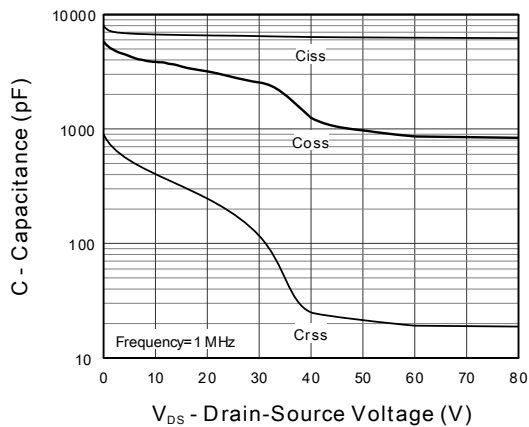


Figure 11. Capacitance

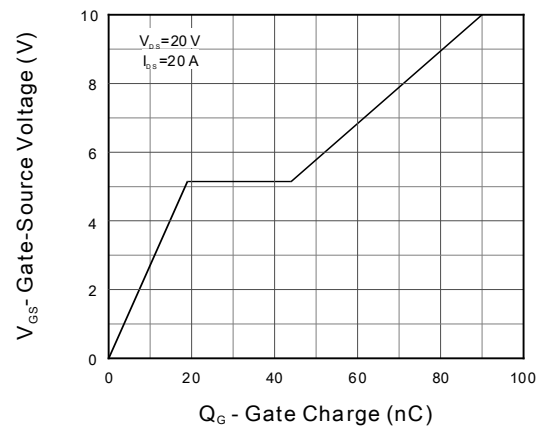
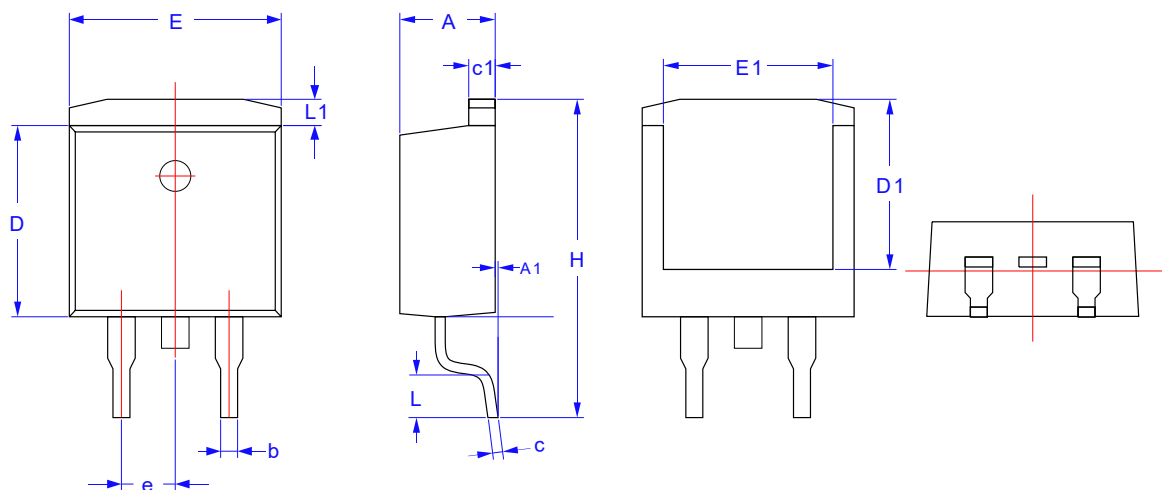


Figure 12. Gate Charge

8. Package Dimensions

TO-263 Package



TOP VIEW

SIDE VIEW

BOTTOM VIEW

SIDE VIEW

Symbol	Dimensions in Millimeters	
	MIN	MAX
A	4.40	4.70
A1	0.00	0.25
b	0.70	0.90
c1	0.40	0.55
c2	1.25	1.35
D	9.00	9.30
D1	7.40	8.40

Symbol	Dimensions in Millimeters	
	MIN	MAX
E	9.80	10.40
E1	7.20	8.40
e	2.54 BSC	
H	14.90	15.25
L	2.00	2.50
L1	1.00	1.40